## Data Sheet

## FEATURES

Dual independent, digitally controlled VGAs
-11.5 dB to $\mathbf{+ 2 0} \mathrm{dB}$ gain range
$0.5 \mathrm{~dB} \pm 0.1 \mathrm{~dB}$ step size
$150 \Omega$ differential input and output
7.5 dB noise figure at maximum gain

OIP3 > 47.5 dBm at 200 MHz
-3 dB upper frequency bandwidth of 700 MHz
Multiple control interface options
Parallel 6-bit control interface (with latch)
Serial peripheral interface (SPI) (with fast attack)
Gain up/down mode
Wide input dynamic range
Low power mode option
Power-down control
Single 5 V supply operation
40-lead, $6 \mathrm{~mm} \times 6 \mathrm{~mm}$ LFCSP package

## APPLICATIONS

Differential ADC drivers
High IF sampling receivers
High output power IF amplification
Instrumentation

## GENERAL DESCRIPTION

The ADL5202 is a digitally controlled, variable gain, wide bandwidth amplifier that provides precise gain control, high output IP3, and low noise figure. The excellent distortion performance and high signal bandwidth make the ADL5202 an excellent gain control device for a variety of receiver applications. The ADL5202 also incorporates a low power mode option that lowers the supply current.

For wide input dynamic range applications, the ADL5202 provides a broad 31.5 dB gain range with 0.5 dB resolution. The gain is adjustable through multiple gain control interface options: parallel, serial peripheral interface, and up/down.
Incorporating proprietary distortion cancellation techniques, the ADL5202 achieves a better than 47.5 dBm output IP3 at frequencies approaching 200 MHz for most gain settings.


The ADL5202 is powered on by applying the appropriate logic level to the PWUPx pins. The quiescent current of the ADL5202 is typically 160 mA in low power mode. When configured in high performance mode for more demanding applications, the quiescent current is 210 mA . When powered down, the ADL5202 consumes less than 14 mA and offers excellent input-to-output isolation. The gain setting is preserved during power-down.

Fabricated on an Analog Devices, Inc., high speed SiGe process, the ADL5202 provides precise gain adjustment capabilities with good distortion performance and low phase error. The ADL5202 amplifier comes in a compact, thermally enhanced 40-lead, $6 \mathrm{~mm} \times 6 \mathrm{~mm}$ LFCSP package and operates over a temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

Rev. D Document Feedback

## TABLE OF CONTENTS

Features ..... 1
Applications. .....  1
Functional Block Diagram ..... 1
General Description .....  1
Revision History ..... 2
Specifications ..... 3
Absolute Maximum Ratings ..... 5
ESD Caution ..... 5
Pin Configuration and Function Descriptions ..... 6
Typical Performance Characteristics ..... 8
Characterization and Test Circuits ..... 15
Theory of Operation ..... 16
Digital Interface Overview ..... 16
Parallel Digital Interface ..... 16
Serial Peripheral Interface (SPI) ..... 16
REVISION HISTORY
1/2017—Rev. C to Rev. D
Change to Features Section and General Description Section .....  1
Changes to Noise/Harmonic Performance Parameter, Table 1 .....  4
1/2015—Rev. B to Rev. CChanges to Table 1 4
Change to Table 3 ..... 6
Gain Up/Down Interface ..... 16
Truth Table ..... 17
Logic Timing ..... 17
Circuit Description ..... 18
Basic Structure ..... 18
Applications Information ..... 19
Basic Connections ..... 19
ADC Driving ..... 19
Layout Considerations ..... 21
Evaluation Board ..... 22
Evaluation Board Control Software ..... 22
Evaluation Board Schematics and Artwork ..... 23
Evaluation Board Configuration Options ..... 27
Outline Dimensions ..... 29
Ordering Guide ..... 29
9/2013-Rev. A to Rev. B
Changed Logic Pins Absolute Maximum Rating from 3.6 V to -0.3 V to +3.6 V (not to exceed |VPOS $-0.5 \mathrm{~V} \mid$ at any time) .... 5 .....  5
12/2012-Rev. 0 to Rev. A
Changes to Layout Consideration Section ..... 21

## SPECIFICATIONS

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=150 \Omega$ at 100 MHz , high performance mode, 2 V p-p differential output, unless otherwise noted.
Table 1.

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Bandwidth <br> Slew Rate <br> Input Return Loss (S11) <br> Output Return Loss (S22) | $\begin{aligned} & \text { Vout }<2 \mathrm{Vp-p}(5.2 \mathrm{dBm}) \\ & 100 \mathrm{MHz} \\ & 100 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & 700 \\ & 5.5 \\ & -17.7 \\ & -16.5 \end{aligned}$ |  | MHz <br> V/ns <br> dB <br> dB |
| INPUT STAGE <br> Maximum Input Swing (Differential) Differential Input Resistance Common-Mode Input Voltage CMRR | VINA+, VINB+ and VINA-, VINB- pins <br> Gain code $=111111$ <br> Gain code $=000000$ |  | $\begin{aligned} & 10.8 \\ & 150 \\ & 1.5 \\ & 40 \end{aligned}$ |  | $\begin{aligned} & \text { Vp-p } \\ & \Omega \\ & V \\ & d B \end{aligned}$ |
| GAIN <br> Maximum Voltage Gain Minimum Voltage Gain Gain Step Size Gain Flatness Gain Temperature Sensitivity Gain Step Response Gain Conformance Error Phase Conformance Error | Gain code $=000000$ <br> Gain code $=111111$ <br> $30 \mathrm{MHz}<\mathrm{fc}_{\mathrm{c}}<200 \mathrm{MHz}$ <br> Gain code $=000000$ <br> For $\mathrm{V}_{\mathbb{I N}}=0.2 \mathrm{~V}$, gain code $=111111$ to 000000 <br> Over 10 dB gain range <br> Over 10 dB gain range |  | $\begin{aligned} & 20 \\ & -11.5 \\ & 0.5 \\ & 0.285 \\ & 0.012 \\ & 15 \\ & \pm 0.03 \\ & 1.0 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB <br> $\mathrm{dB} /{ }^{\circ} \mathrm{C}$ <br> ns <br> dB <br> Degrees |
| OUTPUT STAGE <br> Output Voltage Swing Differential Output Resistance | VOUTx + and VOUTx- pins <br> At P1dB, gain code $=000000$ <br> Differential |  | $\begin{aligned} & 10 \\ & 150 \end{aligned}$ |  | $\begin{aligned} & \text { Vp-p } \\ & \Omega \end{aligned}$ |
| NOISE/HARMONIC PERFORMANCE <br> 46 MHz <br> Second Harmonic <br> Third Harmonic <br> Output IP3 <br> 70 MHz <br> Second Harmonic <br> Third Harmonic <br> Output IP3 <br> 140 MHz <br> Noise Figure <br> Second Harmonic <br> Third Harmonic <br> Output IP3 <br> Output 1 dB Compression Point <br> 300 MHz <br> Second Harmonic <br> Third Harmonic <br> Output IP3 | Gain code $=000000$, high performance mode <br> $\mathrm{V}_{\text {out }}=2 \mathrm{~V}$ p-p <br> $V_{\text {out }}=2 \mathrm{~V}$ p-p <br> $\mathrm{V}_{\text {out }}=2 \mathrm{~V}$ p-p composite <br> Gain code $=000000$, high performance mode <br> $V_{\text {out }}=2 \mathrm{~V}$ p-p <br> $V_{\text {out }}=2 \mathrm{~V}$ p-p <br> $V_{\text {out }}=2 \mathrm{~V}$ p-p composite <br> Gain code $=000000$, high performance mode <br> $\mathrm{V}_{\text {out }}=2 \mathrm{Vp}$ pp <br> $V_{\text {out }}=2 \mathrm{~V}$ p-p <br> $\mathrm{V}_{\text {out }}=2 \mathrm{~V}$ p-p composite <br> Gain code $=000000$, high performance mode <br> $V_{\text {out }}=2 \mathrm{~V}$ p-p <br> $V_{\text {out }}=2 V$ p-p <br> $\mathrm{V}_{\text {out }}=2 \mathrm{~V}$ p-p composite |  | $\begin{aligned} & -92 \\ & -105 \\ & 47.5 \\ & -96 \\ & -105 \\ & 47.5 \\ & \\ & 7.5 \\ & -86 \\ & -105 \\ & 47.5 \\ & 19.5 \\ & \\ & -77 \\ & -91 \\ & 45 \end{aligned}$ |  | dBc dBc dBm <br> dBc dBC dBm dB <br> dBc <br> dBc <br> dBm <br> dBm <br> dBc <br> dBC <br> dBm |


| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| POWER-UP INTERFACE <br> Power-Up Threshold <br> PWUPx Input Bias Current | PWUPA, PWUPB pins <br> Minimum voltage to enable the device Maximum voltage to enable the device | 1.4 | 1 | 3.3 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ |
| GAIN CONTROL INTERFACE <br> $\mathrm{V}_{\mathrm{IH}}$ <br> VIL <br> Maximum Input Bias Current | Minimum/Maximum voltage for a logic high Maximum voltage for a logic low | $1.4{ }^{1}$ |  | $\begin{aligned} & 3.3 \\ & 0.8 \end{aligned}$ | V <br> $\mu \mathrm{A}$ |
| SPITIMING <br> fsclik <br> toh <br> tDs <br> tpw | LATCHA and LATCHB, SCLK, SDIO, data pins 1/tsclk <br> Data hold time <br> Data setup time <br> SCLK high pulse width |  | $\begin{aligned} & 20 \\ & 5 \\ & 5 \\ & 5 \end{aligned}$ |  | MHz <br> ns <br> ns <br> ns |
| POWER INTERFACE <br> Supply Voltage Quiescent Current, Both Channels <br> Power-Down Current, Both Channels | High performance mode $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ <br> Low power mode $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ <br> PWUPx low | 4.5 | 210 <br> 160 <br> 14 | $\begin{aligned} & 5.5 \\ & 250 \\ & 180 \end{aligned}$ | V <br> mA <br> mA <br> mA <br> mA <br> mA |

${ }^{1}$ The minimum value for a logic high on the PM pin is 2.8 V .

## Timing Diagrams



Figure 2. SPI Interface Read/Write Mode Timing Diagram


Figure 3. Up/Down Mode Timing Diagram


Figure 4. Parallel Mode Timing Diagram

## ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
| :--- | :--- |
| Supply Voltage, $\mathrm{V}_{\text {POS }}$ | 5.5 |
| PWUPA, PWUPB, A0 to A5, B0 to B5, | -0.3 V to +3.6 V |
| MODEO, MODE1, PM, LATCHA, LATCHB | (not to exceed \|VPOS - |
|  | $0.5 \mathrm{~V} \mid$ at any time) |
| Input Voltage, $\mathrm{V}_{\mathbb{N}+}, \mathrm{V}_{\mathfrak{N}-}$ | +3.6 V to -1.2 V |
| Internal Power Dissipation | 1.6 W |
| $\theta_{\mathrm{JA}}$ (Exposed Paddle Soldered Down) | $34.6^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\mathrm{c}}$ (At Exposed Paddle) | $3.6^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Junction Temperature | $140^{\circ} \mathrm{C}$ |
| Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 60 sec ) | $240^{\circ} \mathrm{C}$ |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 3. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | $\overline{\mathrm{CSA}} / \mathrm{A} 3$ | Channel A Select ( $\overline{\mathrm{CSA}})$. When serial mode is enabled, a logic low ( $0 \mathrm{~V} \leq \overline{\mathrm{CSA}} \leq 0.8 \mathrm{~V}$ ) selects Channel A . Bit 3 for Channel A Parallel Gain Control Interface (A3). |
| 2 | A4 | Bit 4 for Channel A Parallel Gain Control Interface. |
| 3 | A5 | Bit 5 (MSB) for Channel A Parallel Gain Control Interface. |
| 4 | MODE1 | MSB for Mode Control. With the MODEO pin, selects parallel, SPI, or up/down interface mode. |
| 5 | MODE0 | LSB for Mode Control. With the MODE1 pin, selects parallel, SPI, or up/down interface mode. |
| 6 | PM | Performance Mode. A logic low ( $0 \mathrm{~V} \leq \mathrm{PM} \leq 0.8 \mathrm{~V}$ ) enables high performance mode. A logic high ( $2.8 \mathrm{~V} \leq \mathrm{PM} \leq 3.3 \mathrm{~V}$ ) enables low power mode. |
| 7, 18, 33, EP | GND | Ground. The exposed paddle (EP) must be connected to a low impedance ground pad. |
| 8 | SDIO/B5 | Serial Data Input/Output (SDIO). When $\overline{\mathrm{CSA}}$ or $\overline{\overline{\mathrm{CSB}}}$ is pulled low, SDIO is used for reading and writing to the SPI port. <br> Bit 5 for Channel B Parallel Gain Control Interface (B5). |
| 9 | SCLK/B4 | Serial Clock Input in SPI Mode (SCLK). Bit 4 for Channel B Parallel Gain Control Interface (B4). |
| 10 | $\mathrm{GS} 1 / \overline{\mathrm{CSB}} / \mathrm{B} 3$ | MSB for Gain Step Size Control in Up/Down Mode (GS1). <br> Channel $B$ Select ( $\overline{C S B}$ ). When serial mode is enabled, a logic low ( $0 \mathrm{~V} \leq \overline{\mathrm{CSB}} \leq 0.8 \mathrm{~V}$ ) selects Channel B . Bit 3 for Channel B Parallel Gain Control Interface (B3). |
| 11 | GS0/FA_B/B2 | LSB for Gain Step Size Control in Up/Down Mode (GSO). <br> Fast Attack (FA_B). In serial mode, a logic high ( $1.4 \mathrm{~V} \leq F A \_B \leq 3.3 \mathrm{~V}$ ) attenuates Channel B according to the FA setting in the SPI word. <br> Bit 2 for Channel B Parallel Gain Control Interface (B2). |
| 12 | UPDN_CLK_B/B1 | Clock Interface for Channel B Up/Down Function (UPDN_CLK_B). Bit 1 for Channel B Parallel Gain Control Interface (B1). |
| 13 | UPDN_DAT_B/B0 | Data Pin for Channel B Up/Down Function (UPDN_DAT_B). Bit 0 for Channel B Parallel Gain Control Interface (BO). |
| 14 | LATCHB | Channel $B$ Latch. A logic low ( $0 \mathrm{~V} \leq L A T C H B \leq 0.8 \mathrm{~V}$ ) allows gain changes on Channel B . A logic high $(1.4 \mathrm{~V} \leq \mathrm{LATCHB} \leq 3.3 \mathrm{~V}$ ) prevents gain changes on Channel B. |

## ADL5202

| Pin No. | Mnemonic | Description |
| :---: | :---: | :---: |
| 15 | VINB- | Channel B Negative Input. |
| 16 | VINB+ | Channel B Positive Input. |
| 17 | PWUPB | Channel B Power-Up. A logic high ( $1.4 \mathrm{~V} \leq \mathrm{PWUPB} \leq 3.3 \mathrm{~V}$ ) enables Channel B. |
| 19, 21 | VOUTB- | Channel B Negative Output. |
| 20, 22 | VOUTB+ | Channel B Positive Output. |
| $\begin{aligned} & 23,24,25, \\ & 26,27,28 \end{aligned}$ | VPOS | Positive Power Supply. |
| 29, 31 | VOUTA+ | Channel A Positive Output. |
| 30, 32 | VOUTA- | Channel A Negative Output. |
| 34 | PWUPA | Channel A Power-Up. A logic high ( $1.4 \mathrm{~V} \leq$ PWUPA $\leq 3.3 \mathrm{~V}$ ) enables Channel A. |
| 35 | VINA+ | Channel A Positive Input. |
| 36 | VINA- | Channel A Negative Input. |
| 37 | LATCHA | Channel A Latch. A logic low ( $0 \mathrm{~V} \leq$ LATCHA $\leq 0.8 \mathrm{~V}$ ) allows gain changes on Channel A. A logic high $(1.4 \mathrm{~V} \leq \mathrm{LATCHA} \leq 3.3 \mathrm{~V})$ prevents gain changes on Channel A . |
| 38 | UPDN_DAT_A/AO | Data Pin for Channel A Up/Down Function (UPDN_DAT_A). Bit 0 for Channel A Parallel Gain Control Interface (AO). |
| 39 | UPDN_CLK_A/A1 | Clock Interface for Channel A Up/Down Function (UPDN_CLK_A). Bit 1 for Channel A Parallel Gain Control Interface (A1). |
| 40 | FA_A/A2 | Fast Attack (FA_A). In serial mode, a logic high ( $1.4 \mathrm{~V} \leq \mathrm{FA} \_\mathrm{A} \leq 3.3 \mathrm{~V}$ ) attenuates Channel A according to FA setting in the SPI word. <br> Bit 2 for Channel A Parallel Gain Control Interface (A2). |

## TYPICAL PERFORMANCE CHARACTERISTICS

$\mathrm{V}_{s}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{s}}=\mathrm{R}_{\mathrm{L}}=150 \Omega$ at 200 MHz , high performance mode, 2 V p-p differential output, unless otherwise noted.


Figure 6. Gain vs. Gain Code at $46 \mathrm{MHz}, 140 \mathrm{MHz}$, and 300 MHz


Figure 7. Noise Figure vs. Programmed Gain at 140 MHz


Figure 8. OP1dB vs. Programmed Gain at 140 MHz


Figure 9. Gain vs. Frequency Response (Every $1 d B$ Step)


Figure 10. Noise Figure vs. Frequency at Max, Mid, and Min Gain Outputs


Figure 11. OP1dB vs. Frequency at Maximum Gain, Three Temperatures


Figure 12. Output Third-Order Intercept vs. Frequency at Four Gain Codes


Figure 13. Output Third-Order Intercept vs. Frequency, Three Temperatures at 2 V p-p Composite


Figure 14. Two-Tone Output IMD3 vs. Programmed Gain, at $46 \mathrm{MHz}, 140 \mathrm{MHz}, 300 \mathrm{MHz}$


Figure 15. Output Third-Order Intercept vs. Power at Four Gain Codes, Frequency $=140 \mathrm{MHz}$ at 2 Vp -p Composite


Figure 16. Output Third-Order Intercept vs. Power, Frequency $=140 \mathrm{MHz}$, Three Temperatures


Figure 17. Two-Tone Output IMD3 vs. Frequency, Three Temperatures


Figure 18. Harmonic Distortion vs. Frequency at Four Gain Codes


Figure 19. Harmonic Distortion vs. Frequency, Three Temperatures


Figure 20. OP1dB vs. Programmed Gain at 140 MHz, Low Power Mode


Figure 21. Harmonic Distortion vs. Power at Four Gains,
Frequency $=140 \mathrm{MHz}$


Figure 22. Harmonic Distortion vs. Power, Frequency $=140 \mathrm{MHz}$, Three Temperatures


Figure 23. OP1dB vs. Frequency at Maximum Gain, Three Temperatures, Low Power Mode


Figure 24. Output Third-Order Intercept vs. Frequency at Four Gain Codes, Low Power Mode at 2 Vp-p Composite


Figure 25. Output Third-Order Intercept vs. Frequency, Three Temperatures, Low Power Mode


Figure 26. Two-Tone Output IMD3 vs. Programmed Gain at $46 \mathrm{MHz}, 140 \mathrm{MHz}, 300 \mathrm{MHz}$; Low Power Mode


Figure 27. Output Third-Order Intercept vs. Power at Four Gain Codes, Frequency $=140 \mathrm{MHz}$, Low Power Mode


Figure 28. Output Third-Order Intercept vs. Power, Three Temperatures, Low Power Mode at 2 V p-p Composite


Figure 29. Two-Tone Output IMD3 vs. Frequency, Three Temperatures, Low Power Mode


Figure 30. Harmonic Distortion vs. Frequency at Four Gain Codes, Low Power Mode


Figure 31. Harmonic Distortion vs. Frequency, Three Temperatures, Low Power Mode


Figure 32. Enable Time Domain Response


Figure 33. Harmonic Distortion vs. Power at Four Gain Codes, Frequency $=140 \mathrm{MHz}$, Low Power Mode


Figure 34. Harmonic Distortion vs. Power, Frequency $=140 \mathrm{MHz}$, Three Temperatures, Low Power Mode


Figure 35. Disable Time Domain Response


Figure 36. Gain Step Time Domain Response


Figure 37. S11 Magnitude and Phase vs. Frequency


Figure 38. Gain Step Error, Frequency $=140$ MHz


Figure 39. Large Signal Pulse Response, 0 pF and 5.6 pF, 2 Vp -p Composite


Figure 40. S22 Magnitude and Phase vs. Frequency


Figure 41. Channel Isolation vs. Frequency


Figure 42. Reverse Isolation vs. Frequency


Figure 43. Group Delay vs. Frequency at Max, Mid, and Min Gain Outputs


Figure 44. Phase Variation vs. Gain Code


Figure 45. Disable-State Reverse Isolation vs. Frequency


Figure 46. Common-Mode Rejection Ratio vs. Frequency

## CHARACTERIZATION AND TEST CIRCUITS



Figure 47. Test Circuit for S-Parameters on Dedicated $50 \Omega$ Differential-to-Differential Board


Figure 48. Test Circuit for Distortion, Gain, and Noise


Figure 49. Differential-to-Differential Characterization Board, Circuit Side Layout

## THEORY OF OPERATION

## DIGITAL INTERFACE OVERVIEW

The ADL5202 VGA has three digital gain control options: the parallel control interface, serial peripheral interface, and gain up/down interface. The desired gain control option is selected via two control pins, MODE0 and MODE1 (see Table 4 for the truth table for the mode control pins). The gain code is in a 6 -bit binary format. A voltage of between 1.4 V and 3.3 V is required for a logic high.

Three pins are common to all gain control options: PM, PWUPA, and PWUPB. PM allows the user to choose operation in nominal mode or high performance mode. PWUPA and PWUPB are power-up pins for Channel A and Channel B, respectively. Physical pins are shared among the three interfaces, resulting in as many as three different functions per digital pin (see Table 3).

Table 4. Digital Control Interface Selection Truth Table

| MODE1 | MODEO | Interface |
| :--- | :--- | :--- |
| 0 | 0 | Parallel control |
| 0 | 1 | Serial peripheral (SPI) |
| 1 | 0 | Up/down |
| 1 | 1 | Up/down |

## PARALLEL DIGITAL INTERFACE

The parallel digital interface uses six binary bits (Bits[A5:A0] or Bits[B5:B0]) and a latch pin (LATCHA or LATCHB) per amplifier. The latch pin controls whether the input data latch is transparent or latched. In transparent mode, gain changes as input gain control bits change. In latched mode, gain is determined by the latched gain setting and does not change with changing input gain control bits.

## SERIAL PERIPHERAL INTERFACE (SPI)

The SPI uses three pins (SDIO, SCLK, and $\overline{\mathrm{CSA}}$ or $\overline{\mathrm{CSB}}$ ). The SPI data register consists of two bytes: six gain control bits, two attenuation step size address bits, one read/write bit, and seven don't care bits. SDIO is the serial data input and output pin. The SCLK pin is the serial clock, and $\overline{\mathrm{CSA}}$ or $\overline{\mathrm{CSB}}$ is the channel select pin.


Figure 50. 16-Bit SPI Register
To write to the SPI register, $\overline{\mathrm{CSA}}$ or $\overline{\mathrm{CSB}}$ must be pulled low and 16 clock pulses must be applied to SCLK. Individual channel SPI registers can be selected by pulling $\overline{\mathrm{CSA}}$ or $\overline{\mathrm{CSB}}$ low. By pulling the $\overline{\mathrm{CSA}}$ and $\overline{\mathrm{CSB}}$ pins low simultaneously, the same data can be written to both SPI registers.

To read the SPI register value, the R/W bit must be set high, $\overline{\mathrm{CSA}}$ or $\overline{\mathrm{CSB}}$ must be pulled low, and the part must be clocked. After the register has been read out during the next 16 clock cycles, the SPI is automatically put into write mode. Note that there is only one SDIO pin. Readback from the registers should be performed individually.

## Fast Attack

The fast attack feature, accessible via the SPI, allows the gain to be reduced from its present gain setting by a predetermined step size. Four different attenuation step sizes are available. The truth table for fast attack is shown in Table 5.

Table 5. SPI 2-Bit Attenuation Step Size Truth Table

| FA1 | FA0 | Step Size (dB) |
| :--- | :--- | :--- |
| 0 | 0 | 2 |
| 0 | 1 | 4 |
| 1 | 0 | 8 |
| 1 | 1 | 16 |

SPI fast attack mode is controlled by the FA_A or FA_B pin. A logic high on the FA_A or FA_B pin results in an attenuation that is selected by Bits[FA1:FA0] in the SPI register.

## GAIN UP/DOWN INTERFACE

The GS1 and GS0 pins control the up/down gain step function. Gain is increased by a clock pulse on the UPDN_CLK_A pin or the UPDN_CLK_B pin (rising and falling edges) when the UPDN_DAT_A or UPDN_DAT_B pin is high. Gain is decreased by a clock pulse on the UPDN_CLK_A or UPDN_CLK B pin when the UPDN_DAT_A or UPDN_CLKB pin is low. The truth table for the gain step function is shown in Table 6. Reset is detected by a rising edge latching data having one polarity, with the falling edge latching the opposite polarity. Reset results in a minimum binary gain code of 111111 .

Table 6. Step Size Control Truth Table

| GS1 | GS0 | Step Size (dB) |
| :--- | :--- | :--- |
| 0 | 0 | 0.5 |
| 0 | 1 | 1 |
| 1 | 0 | 2 |
| 1 | 1 | 4 |

The step size is selectable using the GS1 and GS0 pins. The gain is limited by the top and bottom of the control range.


## TRUTH TABLE

Table 7. Gain Code vs. Voltage Gain Lookup Table

| 6-Bit Binary <br> Gain Code | Voltage <br> Gain (dB) | 6-Bit Binary <br> Gain Code | Voltage <br> Gain (dB) |
| :--- | :--- | :--- | :--- |
| 000000 | 20 | 100000 | 4 |
| 000001 | 19.5 | 100001 | 3.5 |
| 000010 | 19 | 100010 | 3 |
| 000011 | 18.5 | 100011 | 2.5 |
| 000100 | 18 | 100100 | 2 |
| 000101 | 17.5 | 100101 | 1.5 |
| 000110 | 17 | 100110 | 1 |
| 000111 | 16.5 | 100111 | 0.5 |
| 001000 | 16 | 101000 | 0 |
| 001001 | 15.5 | 101001 | -0.5 |
| 001010 | 15 | 101010 | -1 |
| 001011 | 14.5 | 101011 | -1.5 |
| 001100 | 14 | 101100 | -2 |
| 001101 | 13.5 | 101101 | -2.5 |
| 001110 | 13 | 101110 | -3 |
| 001111 | 12.5 | 101111 | -3.5 |
| 010000 | 12 | 110000 | -4 |
| 010001 | 11.5 | 110001 | -4.5 |
| 010010 | 11 | 110010 | -5 |
| 010011 | 10.5 | 110011 | -5.5 |
| 010100 | 10 | 110100 | -6 |
| 010101 | 9.5 | 110101 | -6.5 |
| 010110 | 9 | 110110 | -7 |
| 010111 | 8.5 | 110111 | -7.5 |
| 011000 | 8 | 111000 | -8 |
| 011001 | 7.5 | 111001 | -8.5 |
| 011010 | 7 | 111010 | -9 |
| 011011 | 6.5 | 111011 | -9.5 |
| 011100 | 6 | 111100 | -10 |
| 011101 | 5.5 | 111101 | -10.5 |
| 011110 | 5 | 111110 | -11 |
| 011111 | 4.5 | 111111 | -11.5 |
|  |  |  |  |

## LOGIC TIMING

To write to the ADL5202, refer to the timing shown in Figure 2 (reproduced in this section as Figure 52). The write mode uses a 16 -bit serial word on the SDIO pin. The R/W of the word must be low to write Bits[D0:D5], which are the binary weighted codes for the attenuation level $(0=$ minimum attenuation, $63=$ maximum attenuation). The FA0 and FA1 bits control the fast attack step size. The DNC bits are nonfunctional, do not care bits. Reading the ADL5202 SPI register requires the following two steps:

1. Set the $\mathrm{R} / \mathrm{W}$ bit high using a 16 -bit word and the timing described in this section and Figure 52. All other bits are ignored when the R/W bit is high.
2. The SDIO is used as an output during the next sequence. The written pattern is serially clocked out on SDIO using 16 clocks and the timing described in this section and Figure 52. The R/W bit automatically returns low to the write state following the read sequence.


Figure 52. SPI Interface Read/Write Mode Timing Diagram

## CIRCUIT DESCRIPTION

## BASIC STRUCTURE

The ADL5202 is a dual, differential, variable gain amplifier, with each amplifier consisting of a $150 \Omega$ digitally controlled, passive attenuator that is followed by a highly linear transconductance amplifier with feedback.


Figure 53. Simplified Schematic

## Input System

The dc voltage level at the inputs of each amplifier is set by two independent internal voltage reference circuits to approximately 1.6 V . The references are not accessible and cannot be adjusted.

Each amplifier can be powered down by pulling the corresponding power-up pin down to ground (logic low). When powered down, the total current of each amplifier reduces to 7 mA (typical). The dc level at the inputs remains at approximately 1.6 V , regardless of the state of the PWUPA or PWUPB pin.

## Output Amplifier

The gain of the output amplifier is set to 22 dB when driving a $150 \Omega$ load. The input and output resistance of this amplifier is set to $150 \Omega$ in matched condition. If the load or the source resistance is different from $150 \Omega$, the following equations can be used to determine the resulting gain and input/output resistances.

$$
\begin{aligned}
& \text { Voltage Gain }=A_{V}=0.09 \times(2000) / / R_{L} \\
& R_{I N}=\left(2000+R_{L}\right) /\left(1+0.09 \times R_{L}\right) \\
& S 21(\text { Gain })=2 \times R_{I N} /\left(R_{I N}+R_{S}\right) \times A_{V} \\
& R_{\text {OUT }}=\left(2000+R_{S}\right) /\left(1+0.09 \times R_{S}\right)
\end{aligned}
$$

Note that at the maximum attenuation setting, $\mathrm{R}_{\mathrm{s}}$, as seen by the output amplifier, is the output resistance of the attenuator, which is $150 \Omega$. However, at minimum attenuation, $\mathrm{R}_{\mathrm{s}}$ is the source resistance that is connected to the input of the part.

The dc current to the outputs of each amplifier is supplied through two external chokes. The inductance of the chokes and the resistance of the load, in parallel with the output resistance of the device, add a low frequency pole to the response. The parasitic capacitance of the chokes adds to the output capacitance of the part. This total capacitance, in parallel with the load and output resistance, sets the high frequency pole of the device. Generally, the larger the inductance of the choke, the higher its parasitic capacitance. Therefore, this trade-off must be considered when the value and type of the choke are selected. For an operation frequency of 15 MHz to 700 MHz driving a $150 \Omega$ load, $1 \mu \mathrm{H}$ chokes with a self resonant frequency (SRF) of 160 MHz or higher are recommended (such as the 0805LS-102XJBB from Coilcraft). If higher value chokes are used, a 4 MHz zero, due to the internal ac-coupled feedback, causes an increase in S21 of up to 6 dB at frequencies below 4 MHz . The supply current of each amplifier consists of about 35 mA through the VPOS pin and 50 mA through the two chokes combined. The latter increases with temperature at approximately 2.5 mA per $10^{\circ} \mathrm{C}$. The total choke current increases to 75 mA for high performance mode. Each amplifier has two output pins for each polarity, and they are oriented in an alternating fashion. When designing the board, care should be taken to minimize the parasitic capacitance due to the routing that connects the corresponding outputs together. To minimize the parasitic capacitance, a good practice is to avoid any ground or power plane under this routing region and under the chokes.

## Gain Control

The gain of each amplifier can be adjusted using the parallel control interface, the serial peripheral interface, or the gain up/down interface. In general, the gain step size is 0.5 dB , but larger sizes can be programmed using the various interfaces, as described in the Digital Interface Overview section. Each amplifier has a maximum gain of +20 dB (Code 0 ) to -11.5 dB (Code 63).
The noise figure of each amplifier is approximately 7.5 dB at maximum gain setting, and it increases as the gain is reduced. The increase in noise figure is equal to the reduction in gain. The linearity of the part measured at the output is first-order independent of the gain setting. From -4 dB to +20 dB gain, OIP3 is approximately 50 dBm into $150 \Omega$ load at 200 MHz ( 0 dBm per tone). At gain settings below -4 dB , OIP3 drops to approximately 40 dBm .

## APPLICATIONS INFORMATION basic connections

Figure 54 shows the basic connections for operating the ADL5202. A voltage between 4.5 V and 5.5 V should be applied to the VPOS pins. Each supply pin should be decoupled with at least one low inductance, surface-mount ceramic capacitor of $0.1 \mu \mathrm{~F}$, placed as close as possible to the device.
The outputs of the ADL5202 must be pulled up to the positive supply with $1 \mu \mathrm{H}$ RF chokes. The differential outputs are biased to the positive supply and require ac coupling capacitors, preferably $0.1 \mu \mathrm{~F}$. Similarly, the input pins are at bias voltages of about 1.6 V above ground and should be ac-coupled as well. The ac coupling capacitors and the RF chokes are the principle limitations for operation at low frequencies.
The digital pins (mode control pins, associated SPI and parallel gain control pins, PM, PWUPA, and PWUPB) operate on a voltage of 3.3 V .

To enable each channel of the ADL5202, the PWUPA or PWUPB pin must be pulled high ( $1.4 \mathrm{~V} \leq \mathrm{PWUPA} / \mathrm{PWUPB} \leq 3.3 \mathrm{~V}$ ). Taking PWUPA or PWUPB low puts the channels of the ADL5202 in sleep mode, reducing current consumption to approximately 7 mA per channel at ambient.

## ADC DRIVING

The ADL5202 is a highly linear, variable gain amplifier that is optimized for ADC interfacing. The output IMDs and noise floor remain constant throughout the 31.5 dB gain range. This is a valuable feature in a variable gain receiver where it is desirable to maintain a constant instantaneous dynamic range as the receiver range is modified. The output noise is $18 \mathrm{nV} / \sqrt{ } \mathrm{Hz}$, which is compatible with 14 - or 16 -bit ADCs. The two-tone IMDs are usually greater than -100 dB for -1 dBm into $150 \Omega$ or 2 V p-p output. The $150 \Omega$ output impedance makes the task of designing a filter for the high input impedance ADCs more straightforward.


Figure 54. Basic Connections


Figure 55. Wideband ADC Interfacing Example Featuring One-Half of the ADL5202 and the AD9268

Figure 55 shows one-half of the ADL5202 driving a two-pole, 100 MHz low-pass filter into the AD9268. The AD9268 is a 16-bit, 125 MSPS analog-to-digital converter with a buffered wideband input, which presents a $6 \mathrm{k} \Omega$ differential input impedance and requires between a 1 V or 2 V input swing to reach full scale. This example uses the 2 V p-p input. For optimum performance, the ADL5202 should be driven differentially, using an impedance transformer or input balun.


Figure 56. Measured Frequency Response of Wideband ADC Interface, as Depicted in Figure 55
Figure 55 uses a 1:3 impedance transformer to provide the $150 \Omega$ input impedance of the ADL5202 with a matched input. The outputs of the ADL5202 are biased through the two $1 \mu \mathrm{H}$ inductors, and the two $0.1 \mu$ fapacitors on the outputs decouple the 5 V inductor voltage from the input common-mode voltage of the AD9268. The two $75 \Omega$ resistors provide the $150 \Omega$ load to the ADL5202 whose gain is load dependent. The 56 nH inductors and 4 pF capacitor constitute the ( $100 \mathrm{MHz}-1 \mathrm{~dB}$ ) low-pass filter. The two $33 \Omega$ isolation resistors suppress any switching currents from the ADC input sample-and-hold circuitry. The circuit depicted in Figure 55 provides variable gain, isolation, filtering, and source matching for the AD9268. Using this circuit with the ADL5202 in a gain of 20 dB (maximum gain), an SNR of 69 dB , and an SFDR performance of $>86 \mathrm{dBc}$ is achieved at 100 MHz , as shown in Figure 57.


Figure 57. Measured Single-Tone Performance of the Circuit in Figure 55 for a 100 MHz Input Signal


Figure 58. Measured Two-Tone Performance of the Circuit in Figure 55 for a 100 MHz Input Signal

An alternative narrow-band approach is presented in Figure 59. By designing a narrow band-pass antialiasing filter between the ADL5202 and the target ADC, the output noise of the ADL5202 outside of the intended Nyquist zone can be attenuated, helping to preserve the available SNR of the ADC. In general, the SNR improves by several decibels ( dB ) when including a reasonable order antialiasing filter. In this example, a low loss 1:3 input transformer is used to match the $150 \Omega$ balanced input of the ADL5202 to a $50 \Omega$ unbalanced source, resulting in minimum insertion loss at the input.

Figure 59 is optimized for driving some of the Analog Devices popular unbuffered ADCs, such as the AD9246, AD9640, and AD6655. Table 8 includes antialiasing filter component recommendations for popular IF sampling center frequencies. Inductor L5 works in parallel with the on-chip ADC input capacitance and a portion of the capacitance presented by C 4 to form a resonant tank circuit. The resonant tank helps to ensure that the ADC input acts like a real resistance at the target center frequency.
In addition, the L6 inductor shorts the ADC inputs at dc, which introduces a zero into the transfer function. The ac coupling capacitors and the bias chokes introduce additional zeros into the
transfer function. The final overall frequency response takes on a band-pass characteristic, helping to reject noise outside of the intended Nyquist zone. Table 8 provides initial suggestions for prototyping purposes. Some empirical optimization may be needed to help compensate for actual PCB parasitics.

## LAYOUT CONSIDERATIONS

The ADL5202 has two output pins for each polarity, and they are oriented in an alternating fashion. When designing the board, care should be taken to minimize the parasitic capacitance due to the routing that connects the corresponding outputs together. A good practice is to avoid any ground or power plane under this routing region and under the chokes to minimize the parasitic capacitance.

If the common-mode load capacitance including the capacitance of the trace is $>2 \mathrm{pF}$, use parasitic suppressing resistors at the device output pins. The resistors should be placed in the output traces just after the crossover connections. Use $5 \Omega$ series resistors (Size 0402) to adequately de-Q the output system without a significant decrease in gain.


Figure 59. Narrow-Band IF Sampling Solution for Unbuffered ADC Applications

Table 8. Interface Filter Recommendations for Various IF Sampling Frequencies

| Center Frequency | 1 dB Bandwidth | L1 | C2 | L3 | C4 | L5 | L6 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 96 MHz | 27 MHz | 68 nH | 15 pF | 220 nH | 15 pF | 68 nH | 150 nH |
| 140 MHz | 31 MHz | 47 nH | 11 pF | 150 nH | 11 pF | 47 nH | 82 nH |
| 170 MHz | 25 MHz | 39 nH | 10 pF | 120 nH | 10 pF | 47 nH | 51 nH |
| 211 MHz | 40 MHz | 30 nH | 7 pF | 100 nH | 7.5 pF | 30 nH | 43 nH |

## ADL5202

## EVALUATION BOARD

The ADL5202 evaluation board is available with software to program the variable gain control. It is a 4-layer board with a split ground plane for analog and digital sections. Special care is taken to place the power decoupling capacitors close to the device pins. The board is designed for easy single-ended (through a Mini-Circuits TC3-1T+ RF transformer) or differential configuration for each channel.

## EVALUATION BOARD CONTROL SOFTWARE

The ADL5202 evaluation board is configured with a USBfriendly interface to program the gain of the ADL5202. The software graphic user interface (see Figure 60) lets users select a particular gain mode and gain level to write to the device and also to read back data from the SDIO pin, showing the currently programmed gain setting. The software setup files can be downloaded from the ADL5202 product page at www.analog.com.

## EVALUATION BOARD SCHEMATICS AND ARTWORK



Figure 61. Evaluation Board Schematic


Figure 62. RF Output Detail


Figure 63. Schematic for the USB Section of the Evaluation Board
Rev. D|Page 25 of 29


## EVALUATION BOARD CONFIGURATION OPTIONS

## Configuration Options for the Main Section

Table 9. Bill of Materials for Main Section

| Components | Function | Default Conditions |
| :---: | :---: | :---: |
| C24 to C27, C51 | Power supply decoupling. Nominal supply decoupling consists of a $0.1 \mu \mathrm{~F}$ capacitor to ground. | C24 to C27, C51 = 0.1 ¢F (Size 0603) |
| $\begin{aligned} & \text { VPOS, 3V3 } \\ & \text { GND } \end{aligned}$ | Power supply connections. | VPOS, 3 V3 (test loop red) installed GND (test loop black) installed |
| DUT1 | Evaluation device. | Installed |
| INA+, INA- <br> INB+, INB- <br> T1, T2, C18 to C23, R8, R9, R20 to R29, R88, R89 | Input interfaces. The INA+ and INA- input SMA connectors are used to drive the Channel A balun in a single-ended fashion. The INB+ and INBinput SMAs are used to drive the Channel $B$ balun in a single-ended fashion. The default configuration of the evaluation board is for single-ended operation. <br> T1 and T2 are 3:1 impedance ratio RF transformers that are used to transform a $50 \Omega$, single-ended input into a $150 \Omega$ balanced differential signal. C18 and C19 are balun decoupling capacitors. C20 to C23 are used for dc blocking purposes. <br> R20 to R29 are provided for generic placement of matching components. R88 and R89 are populated to ground on one side of the transformer primary, creating the $50 \Omega$ single-ended input. | INA+ (SMA connector) installed INA- (SMA connector) installed INB+ (SMA connector) installed INB- (SMA connector) installed T1, T2 = TC3-1T+ (Mini-Circuits) C18 to C23 $=0.1 \mu \mathrm{~F}$ (Size 0603) R8, R9, R26 to R29 $=0 \Omega$ (Size 0402) R20 to R25, R88, R89 = open |
| $\begin{aligned} & \text { OUTA+, OUTA- } \\ & \text { OUTB+, INB- } \\ & \text { T3, T4, C36 to C45, } \\ & \text { R63 to R82, L1 to L4 } \\ & \text { VXA, VXB } \end{aligned}$ | Output interfaces. The OUTA+ and OUTA- output SMA connectors are used to load the Channel A balun in a single-ended fashion. The default configuration of the evaluation board is for single-ended operation. The OUTB+ and OUTB- output SMAs are used to load the Channel B balun in a singleended fashion. The default configuration of the evaluation board is for single-ended operation. <br> T3 and T4 are 3:1 impedance ratio transformers used to transform a $50 \Omega$, single-ended output into a $150 \Omega$ balanced differential load. <br> C40 to C43 are used for ac coupling. C44 and C45 are balun decoupling capacitors. <br> R69 to R76 are provided for generic placement of matching components. By removing R79 and R80 and installing $0 \Omega$ at R81 and R82, the output is converted to a differential output. L1 to L 4 provide dc bias to the output stages. R67 and R68 provide a connection to the 5 V power plane. Optionally, R67 and R68 can be removed and the output stage biased through the VXA and VXB terminals. | OUTA+ (SMA connector) installed OUTA- (SMA connector) installed OUTB+ (SMA connector) installed OUTB- (SMA connector) installed T3, T4 = TC3-1T+ (mini-circuits) C36 to C45 $=0.1 \mu \mathrm{~F}$ (Size 0603) R63 to R72, R77 to R80 $=0 \Omega$ (Size 0402) R73 to R76, R81, R82 = open L1, L2, L3, L4 = $1 \mu \mathrm{H}$ (Size 0805) VXA, VXB (test loop) installed |
| P1, P2, PWUPA, PWUPB, R30 | Power-up interface. The ADL5202 is powered up by applying a logic high ( $1.4 \mathrm{~V} \leq$ PWUPA/PWUPB $\leq 3.3 \mathrm{~V}$ ) to PWUPA and PWUPB from an external source or by installing a shunt between Pin1 and Pin 2 of P 1 andP2. | P1 installed for enable <br> P2 installed for enable <br> PWUPA (SMA connector) installed PWUPB (SMA connector) installed R30 $=$ open |
| A0 to A5, B0 to B5, LATCHA, LATCHB, PM, MODE0, MODE1 R10 to R19, R31 to R62, R84 to R87, <br> C28 to C35, C47 to C50 | Gain control interface. All of the gain control functions are fully controlled via the USB microcontroller by using the supplied software. Three-pin headers allow for manual operation of the gain control, if desired. <br> The R31 to R34, R45, R46, R53, R54, and R84 to R87 resistors and the C28 to C35 and C47 to C50 capacitors allow for the generic placement of filter components. <br> The R10 to R19, R31 to R62, and R84 to R87 resistors isolate the gain control pins from the microcontroller and provide current limiting. | A0 to A5 (3-pin header) installed B0 to B5 (3-pin header) installed LATCHA (3-pin header) installed LATCHB (3-pin header) installed MODEO (3-pin header) installed MODE1 (3-pin header) installed PM (3-pin header) installed R10 to R19 $=1 \mathrm{k} \Omega$ (Size 0603) R35 to R44 = $1 \mathrm{k} \Omega$ (Size 0603) <br> R47 to R52 $1 \mathrm{k} \Omega$ (Size 0603) <br> R55 to R62 $1 \mathrm{k} \Omega$ (Size 0603) <br> R31 to R34 = open <br> R45, R46 = open <br> R53, R54 = open <br> R84 to R87 = open <br> C28 to C35 = open <br> C 47 to $\mathrm{C} 50=$ open |

## ADL5202

## Configuration Options for the USB Section

Table 10. Bill of Materials for USB Section

| Components | Default Conditions |
| :--- | :--- |
| C7, C8 | 22 pF (Size 0603) |
| C13 | 1000 pF (Size 0603) |
| C2, C3, C4, C6, C10, C11, C12, C14, C16, C46 | $0.1 \mu \mathrm{FF}$ (Size 0402) |
| C9, C15 | $1 \mu \mathrm{~F}$ (Size 0402) |
| C1, C5 | 10 pF (Size 0402) |
| CR1 | Green LED ( Panasonic LNJ308G8TRA) |
| P3 | USB SMT connector (Hirose Electric UX60A-MB-5ST 240-0003-4) |
| R1, R2, R5 | $2 \mathrm{k} \Omega$ (Size 0603) |
| R6, | $78.7 \mathrm{k} \Omega$ (Size 0603) |
| R7 | $140 \mathrm{k} \Omega$ (Size 0603) |
| R3, R4 | $100 \mathrm{k} \Omega$ (Size 0603) |
| R83 | $0 \Omega$ (Size 0603) |
| U2 | USB microcontroller (Cypress CY7C68013A-56LFXC) |
| U1 | 64 kB EEPROM (Microchip 24LC64-I/SN) |
| U3 | Low dropout regulator (Analog Devices ADP3334ACPZ) |
| Y1 | 24 MHz crystal oscillator (AEL Crystals X24M0000000S244) |

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WJJD.
Figure 66. 40-Lead Lead Frame Chip Scale Package [LFCSP_WQ]
$6 \mathrm{~mm} \times 6 \mathrm{~mm}$ Body, Very Very Thin Quad (CP-40-10)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| ADL5202ACPZ-R7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $40-L e a d ~ L F C S P \_W Q, ~ 7 " T a p e ~ a n d ~ R e e l ~$ <br> Evaluation Board | CP-40-10 |
| ADL5202-EVALZ |  |  |  |

[^0]
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[^0]:    ${ }^{1} \mathrm{Z}=$ RoHS Compliant Part.

